

Basic information

2013/2918(DEA)

DEA - Delegated acts procedure

Exemption for lead in solders, termination coatings of electrical and electronic components and printed circuit boards, connections of electrical wires, shields and enclosed connectors

Supplementing [2008/0240\(COD\)](#)

Subject

3.40.06 Electronics, electrotechnical industries, ICT, robotics

3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)

Procedure completed - delegated act enters into force